

# Product Change Notice



**PCN:** PCN\_KVR16LE11S8\_4I\_C6  
**Date:** March 3, 2017

**Kingston Technology Company**  
17600 Newhope Street  
Fountain Valley, CA 92708  
USA

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**Type of Change:** Phase Out for End of Life

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**Description of Change:** Build 9965432-083.A00LF using Hynix B Die is being phased out due to DRAM component end of life. Replacement build 9965432-090.A00LF using Hynix D Die has been qualified and released.

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**Product(s) Affected:** KVR16LE11S8/4I

**BOM Number:** 9965432-090.A00LF (Hynix D Die) – New  
9965432-083.A00LF (Hynix B Die) – Phasing Out

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**Product Description:** 4GB DDR3L-1600 ECC Unbuffered DIMM CL11 1Rx8 1.35V Intel Certified

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**Phase Out Notice:** March 3, 2017

**Target End of Life Date:** June 1, 2017 \*

*\* 90-day target EOL date likely to be pulled in due to market conditions affecting DRAM availability. Please contact your Kingston representative to forecast replacement build demand.*